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60 V, 3.8 A NPN low V_{CEsat} (BISS) transistor Rev. 01 — 31 January 2010

Product data sheet

1. **Product profile**

1.1 General description

NPN low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a SOT23 (TO-236AB) small Surface-Mounted Device (SMD) plastic package.

PNP complement: PBSS4041PT.

1.2 Features

- Very low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- High energy efficiency due to less heat generation
- AEC-Q101 qualified
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

1.3 Applications

- Loadswitch
- Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

1.4 Quick reference data

Table 1. **Quick reference data**

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|---|--|--------------|-----|-----|------|
| V_{CEO} | collector-emitter voltage | open base | - | - | 60 | V |
| I _C | collector current | | - | - | 3.8 | А |
| I _{CM} | peak collector current | single pulse; $t_p \leq 1 \text{ ms}$ | - | - | 8 | A |
| R _{CEsat} | collector-emitter saturation resistance | l _C = 3 A; l _B = 300 mA | <u>[1]</u> - | 46 | 66 | mΩ |

 $\label{eq:point} \begin{tabular}{ll} \end{tabular} \end{tabular} \begin{tabular}{ll} \end{tabular} \end{tabular} \end{tabular} \end{tabular} \end{tabular} \end{tabular} \begin{tabular}{ll} \end{tabular} \end{ta$



60 V, 3.8 A NPN low V_{CEsat} (BISS) transistor

2. Pinning information

| Table 2. | Pinning | | |
|----------|-------------|--------------------|----------------|
| Pin | Description | Simplified outline | Graphic symbol |
| 1 | base | | |
| 2 | emitter | | 3 |
| 3 | collector | | |
| | | | sym021 |

3. Ordering information

| Table 3. Orde | ering inform | ation | |
|---------------|--------------|--|---------|
| Type number | Package | | |
| | Name | Description | Version |
| PBSS4041NT | - | plastic surface-mounted package; 3 leads | SOT23 |

4. Marking

| Table 4. Marking codes | |
|------------------------------|-----------------------------|
| Type number | Marking code ^[1] |
| PBSS4041NT | *ВК |
| [1] * = -: made in Hong Kong | |

* = p: made in Hong Kong

- * = t: made in Malaysia
- * = W: made in China

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------------|-------------------------------|-----|-----|------|
| V _{CBO} | collector-base voltage | open emitter | - | 60 | V |
| V _{CEO} | collector-emitter voltage | open base | - | 60 | V |
| V _{EBO} | emitter-base voltage | open collector | - | 5 | V |
| I _C | collector current | | - | 3.8 | А |
| I _{CM} | peak collector current | single pulse; $t_p \leq 1 ms$ | - | 8 | A |
| I _B | base current | | - | 1 | А |

60 V, 3.8 A NPN low V_{CEsat} (BISS) transistor

| Table 5. | Limiting | values | continued |
|----------|----------|--------|-----------|
|----------|----------|--------|-----------|

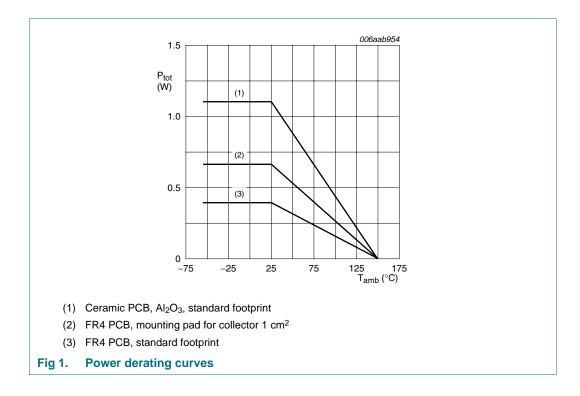
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|-------------------------|------------------------------|-----|-----|------|------|
| P _{tot} | total power dissipation | $T_{amb} \leq 25 ~^{\circ}C$ | [1] | - | 390 | mW |
| | | | [2] | - | 660 | mW |
| | | | [3] | - | 1100 | mW |
| Tj | junction temperature | | | - | 150 | °C |
| T _{amb} | ambient temperature | | | -55 | +150 | °C |
| T _{stg} | storage temperature | | | -65 | +150 | °C |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.



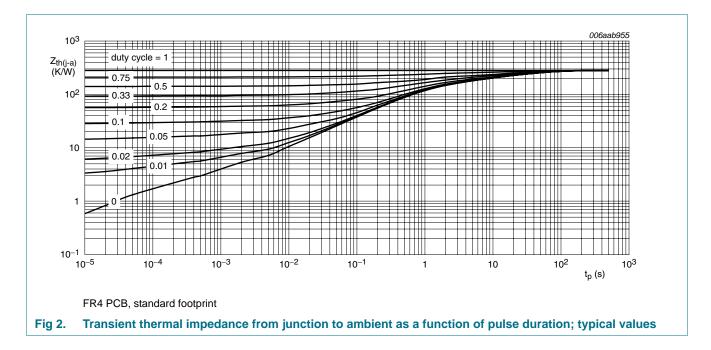
60 V, 3.8 A NPN low V_{CEsat} (BISS) transistor

6. Thermal characteristics

| Table 6. | Thermal characteristics | | | | | |
|-----------------------|--|-------------|--------------|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| - uiu-a) | thermal resistance from junction to ambient | in free air | <u>[1]</u> - | - | 320 | K/W |
| | | | [2] _ | - | 190 | K/W |
| | | | <u>[3]</u> _ | - | 115 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | - | - | 62 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

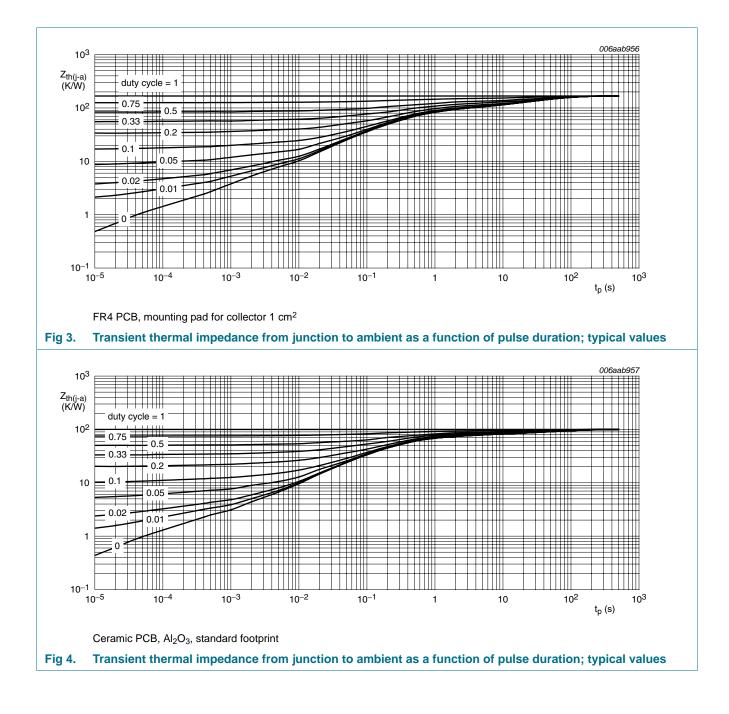


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PBSS4041NT

60 V, 3.8 A NPN low V_{CEsat} (BISS) transistor



PBSS4041NT 1

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7. Characteristics

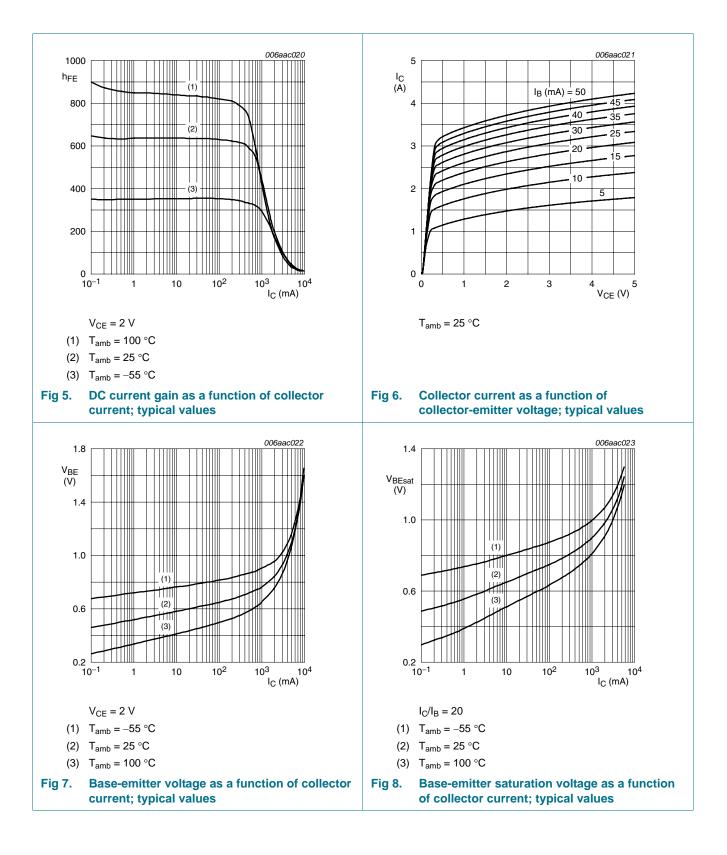
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|--------------------|---|--|------------|-----|------|------|------|
| I _{CBO} | collector-base cut-off | $V_{CB} = 60 \text{ V}; \text{ I}_{E} = 0 \text{ A}$ | | - | - | 100 | nA |
| | current | $V_{CB} = 60 \text{ V}; I_E = 0 \text{ A};$ T _j = 150 °C | | - | - | 50 | μΑ |
| I _{CES} | collector-emitter cut-off current | $V_{CE} = 48 \text{ V}; V_{BE} = 0 \text{ V}$ | | - | - | 100 | nA |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$ | | - | - | 100 | nA |
| h _{FE} | DC current gain | $V_{CE} = 2 \text{ V}; I_{C} = 500 \text{ mA}$ | | 300 | 500 | - | |
| | | $V_{CE} = 2 \text{ V}; \text{ I}_{C} = 1 \text{ A}$ | [1] | 250 | 400 | - | |
| | | $V_{CE} = 2 V; I_C = 2 A$ | [1] | 120 | 170 | - | |
| | | $V_{CE} = 2 \text{ V}; \text{ I}_{C} = 4 \text{ A}$ | [1] | 30 | 50 | - | |
| V _{CEsat} | collector-emitter | $I_{C} = 500 \text{ mA}; I_{B} = 50 \text{ mA}$ | | - | 29 | 40 | mV |
| | saturation voltage | I _C = 1 A; I _B = 50 mA | [1] | - | 57 | 80 | mV |
| | | I _C = 1 A; I _B = 10 mA | [1] | - | 100 | 140 | mV |
| | | $I_{C} = 2 \text{ A}; I_{B} = 40 \text{ mA}$ | [1] | - | 135 | 190 | mV |
| | I _C = 4 A; I _B = 200 mA | [1] | - | 215 | 300 | mV | |
| | | I _C = 3 A; I _B = 300 mA | [1] | - | 140 | 200 | mV |
| R _{CEsat} | collector-emitter saturation resistance | I _C = 3 A; I _B = 300 mA | <u>[1]</u> | - | 46 | 66 | mΩ |
| V _{BEsat} | base-emitter | I _C = 1 A; I _B = 100 mA | [1] | - | 0.94 | 1.05 | V |
| | saturation voltage | I _C = 3 A; I _B = 300 mA | [1] | - | 1.1 | 1.2 | V |
| | | $I_{\rm C} = 4$ A; $I_{\rm B} = 400$ mA | [1] | - | 1.2 | 1.3 | V |
| V _{BEon} | base-emitter turn-on voltage | $V_{CE} = 2 \text{ V}; I_{C} = 2 \text{ A}$ | | - | 0.83 | 0.9 | V |
| t _d | delay time | V_{CC} = 12.5 V; I _C = 1 A; | | - | 13 | - | ns |
| t _r | rise time | I _{Bon} = 0.05 A; I _{Boff} = -0.05 A | | - | 140 | - | ns |
| t _{on} | turn-on time | Bolt0.00 K | | - | 153 | - | ns |
| t _s | storage time | | | - | 735 | - | ns |
| t _f | fall time | | | - | 320 | - | ns |
| t _{off} | turn-off time | | | - | 1055 | - | ns |
| f _T | transition frequency | V _{CE} = 10 V; I _C = 100 mA; f = 100 MHz | | - | 175 | - | MHz |
| C _c | collector capacitance | $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz | | - | 17 | - | pF |

 $\label{eq:point} \begin{tabular}{ll} \mbox{Pulse test: } t_p \leq 300 \ \mu \mbox{s; } \delta \leq 0.02. \end{tabular}$

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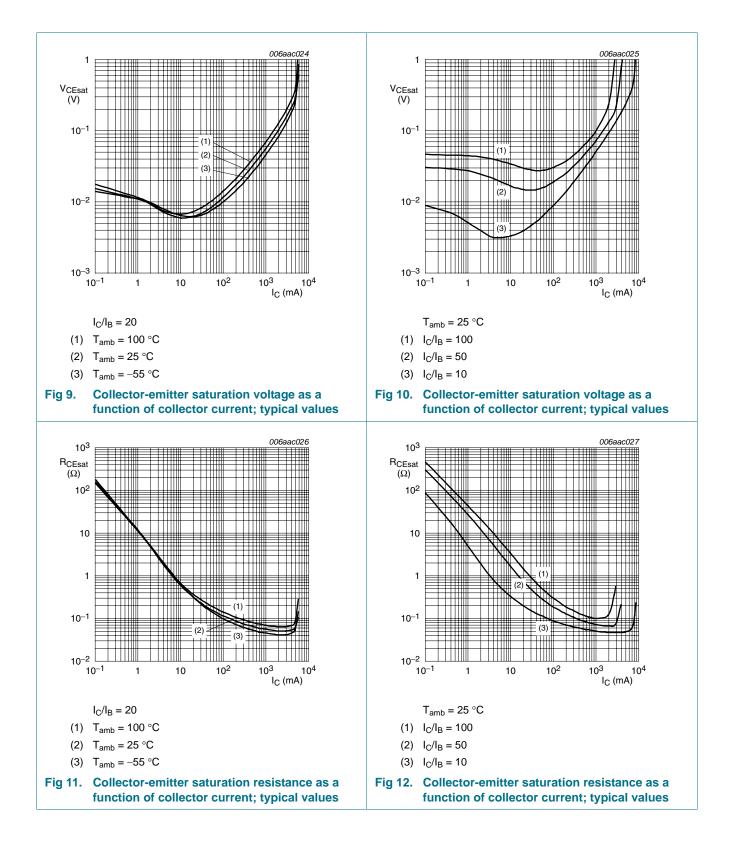
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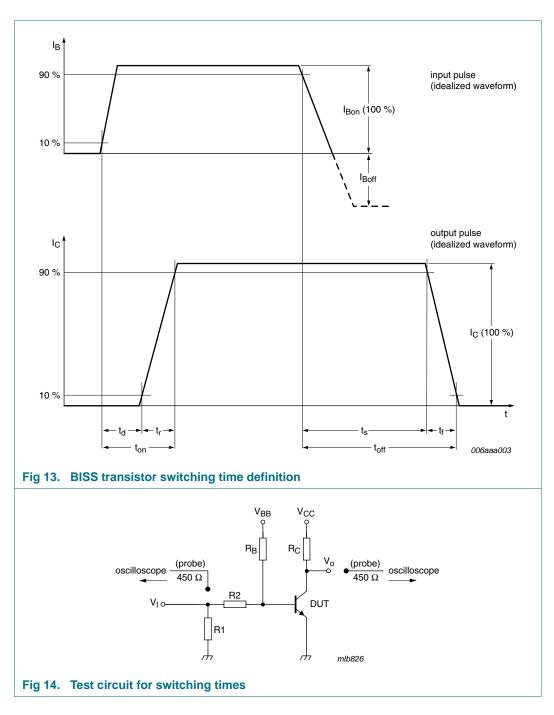
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60 V, 3.8 A NPN low V_{CEsat} (BISS) transistor

8. Test information

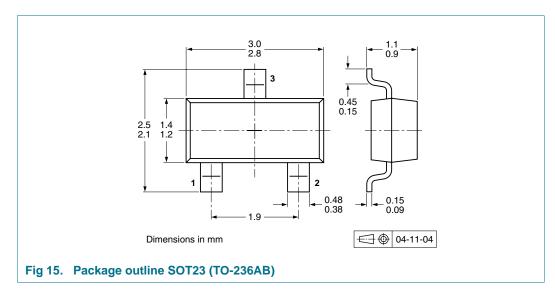


8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

60 V, 3.8 A NPN low V_{CEsat} (BISS) transistor

9. Package outline



10. Packing information

Table 8. Packing methods

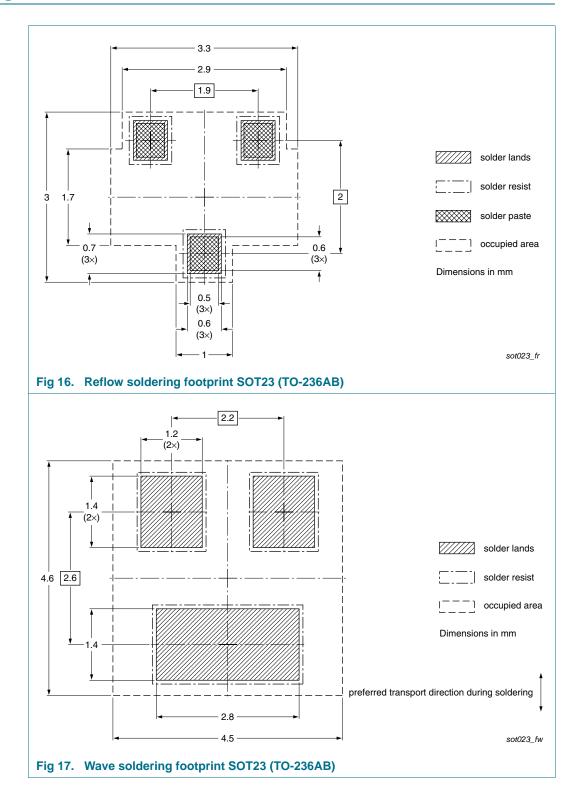
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description | Packing quantity | |
|-------------|---------|--------------------------------|------------------|-------|
| | | | 3000 | 10000 |
| PBSS4041NT | SOT23 | 4 mm pitch, 8 mm tape and reel | -215 | -235 |

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

60 V, 3.8 A NPN low V_{CEsat} (BISS) transistor

11. Soldering



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12. Revision history

| Table 9. Revision hi | istory | | | |
|----------------------|--------------|--------------------|---------------|------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| PBSS4041NT_1 | 20100131 | Product data sheet | - | - |

60 V, 3.8 A NPN low V_{CEsat} (BISS) transistor

13. Legal information

13.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PBSS4041NT_1
Product data sheet

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15. Contents

| 1 | Product profile 1 |
|------|---------------------------|
| 1.1 | General description 1 |
| 1.2 | Features |
| 1.3 | Applications 1 |
| 1.4 | Quick reference data 1 |
| 2 | Pinning information 2 |
| 3 | Ordering information 2 |
| 4 | Marking 2 |
| 5 | Limiting values 2 |
| 6 | Thermal characteristics 4 |
| 7 | Characteristics 6 |
| 8 | Test information 9 |
| 8.1 | Quality information 9 |
| 9 | Package outline 10 |
| 10 | Packing information 10 |
| 11 | Soldering 11 |
| 12 | Revision history 12 |
| 13 | Legal information 13 |
| 13.1 | Data sheet status 13 |
| 13.2 | Definitions 13 |
| 13.3 | Disclaimers |
| 13.4 | Trademarks |
| 14 | Contact information 13 |
| 15 | Contents 14 |

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